

In re Patent Application of:

**MEARS ET AL.**

Serial No. **10/647,069**

Confirmation No. **9700**

Filed: **8/22/03**

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**In the Claims:**

1. (original) A semiconductor device comprising:  
a substrate; and  
at least one MOSFET adjacent said substrate and  
comprising

a superlattice channel including a plurality of  
stacked groups of layers, and

source and drain regions laterally adjacent said  
superlattice channel and a gate overlying said superlattice  
channel for causing transport of charge carriers through  
said superlattice channel in a parallel direction relative  
to the stacked groups of layers,

each group of layers of said superlattice channel  
comprising a plurality of stacked base semiconductor  
monolayers defining a base semiconductor portion and an  
energy band-modifying layer thereon,

said energy-band modifying layer comprising at  
least one non-semiconductor monolayer constrained within a  
crystal lattice of adjacent base semiconductor portions so  
that said superlattice channel has a higher charge carrier  
mobility in the parallel direction than would otherwise be  
present.

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2. (original) A semiconductor device according to Claim 1 wherein said superlattice channel has a common energy band structure therein.

3. (original) A semiconductor device according to Claim 1 wherein the charge carriers having the higher mobility comprise at least one of electrons and holes.

4. (original) A semiconductor device according to Claim 1 wherein each base semiconductor portion comprises silicon.

5. (original) A semiconductor device according to Claim 1 wherein each energy band-modifying layer comprises oxygen.

6. (original) A semiconductor device according to Claim 1 wherein each energy band-modifying layer is a single monolayer thick.

7. (original) A semiconductor device according to Claim 1 wherein each base semiconductor portion is less than eight monolayers thick.

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8. (original) A semiconductor device according to Claim 1 wherein each base semiconductor portion is two to six monolayers thick.

9. (original) A semiconductor device according to Claim 1 wherein said superlattice further has a substantially direct energy bandgap.

10. (original) A semiconductor device according to Claim 1 wherein said superlattice further comprises a base semiconductor cap layer on an uppermost group of layers.

11. (currently amended) A semiconductor device according to Claim ~~11~~ 10 wherein said gate comprises a gate electrode layer and a gate dielectric layer between said gate electrode layer and said base semiconductor cap layer.

12. (original) A semiconductor device according to Claim 1 wherein all of said base semiconductor portions are a same number of monolayers thick.

13. (original) A semiconductor device according to Claim 1 wherein at least some of said base semiconductor portions are a different number of monolayers thick.

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14. (original) A semiconductor device according to Claim 1 wherein all of said base semiconductor portions are a different number of monolayers thick.

15. (original) A semiconductor device according to Claim 1 wherein each non-semiconductor monolayer is thermally stable through deposition of a next layer.

16. (original) A semiconductor device according to Claim 1 wherein each base semiconductor portion comprises a base semiconductor selected from the group consisting of Group IV semiconductors, Group III-V semiconductors, and Group II-VI semiconductors.

17. (original) A semiconductor device according to Claim 1 wherein each energy band-modifying layer comprises a non-semiconductor selected from the group consisting of oxygen, nitrogen, fluorine, and carbon-oxygen.

18. (original) A semiconductor device according to Claim 1 wherein the higher mobility results from a lower conductivity effective mass for the charge carriers in the parallel direction than would otherwise occur.

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19. (original) A semiconductor device according to Claim 18 wherein the lower conductivity effective mass is less than two-thirds the conductivity effective mass that would otherwise occur.

20. (original) A semiconductor device according to Claim 1 wherein said superlattice further comprises at least one type of conductivity dopant therein.

21. (original) A semiconductor device comprising:  
a substrate; and  
at least one MOSFET adjacent said substrate and  
comprising

a superlattice channel comprising a plurality of stacked groups of layers, and

source and drain regions laterally adjacent said superlattice channel and a gate overlying said superlattice channel for causing transport of charge carriers through said superlattice channel in a parallel direction relative to the stacked groups of layers,

each group of layers of said superlattice channel comprising a plurality of stacked silicon atomic layers

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defining a silicon portion and an energy band-modifying layer thereon,

said energy-band modifying layer comprising at least one oxygen atomic layer constrained within a crystal lattice of adjacent silicon portions so that said superlattice has a higher charge carrier mobility than would otherwise be present.

22. (original) A semiconductor device according to Claim 21 wherein said superlattice channel has a common energy band structure therein.

23. (original) A semiconductor device according to Claim 21 wherein the charge carriers having the lower conductivity effective mass comprise at least one of electrons and holes.

24. (original) A semiconductor device according to Claim 21 wherein each energy band-modifying layer is a single atomic layer thick.

25. (original) A semiconductor device according to Claim 21 wherein each silicon portion is less than eight atomic layers thick.

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26. (original) A semiconductor device according to Claim 21 wherein each silicon portion is two to six atomic layers thick.

27. (original) A semiconductor device according to Claim 21 wherein said superlattice channel further has a substantially direct energy bandgap.

28. (original) A semiconductor device according to Claim 21 wherein said superlattice channel further comprises a silicon cap layer on an uppermost group of layers.

29. (currently amended) A semiconductor device according to Claim ~~29~~ 28 wherein said gate comprises a gate electrode layer and a gate dielectric layer between said gate electrode layer and said base semiconductor cap layer.

30. (original) A semiconductor device according to Claim 21 wherein all of said silicon portions are a same number of atomic layers thick.

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31. (original) A semiconductor device according to Claim 21 wherein at least some of said silicon portions are a different number of atomic layers thick.

32. (original) A semiconductor device according to Claim 21 wherein all of said silicon portions are a different number of atomic layers thick.

33. (original) A semiconductor device according to Claim 21 wherein the higher charge carrier mobility results from a lower conductivity effective mass for charge carriers in the parallel direction than would otherwise occur.

34. (original) A semiconductor device according to Claim 21 wherein said superlattice channel further comprises at least one type of conductivity dopant therein.

35. (original) A semiconductor device comprising:  
a substrate; and  
at least one MOSFET adjacent said substrate and  
comprising  
a superlattice channel comprising a plurality of  
stacked groups of layers, and



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source and drain regions laterally adjacent said superlattice channel and a gate overlying said superlattice channel for causing transport of charge carriers through said superlattice channel in a parallel direction relative to the stacked groups of layers,

each group of layers of said superlattice channel comprising less than eight stacked base semiconductor monolayers defining a base semiconductor portion and an energy band-modifying layer thereon,

said energy-band modifying layer comprising a single non-semiconductor monolayer constrained within a crystal lattice of adjacent base semiconductor portions so that said superlattice has a high charge carrier mobility in the parallel direction than would otherwise be present.

36. (original) A semiconductor device according to Claim 35 wherein said superlattice channel has a common energy band structure therein.

37. (original) A semiconductor device according to Claim 35 wherein the charge carriers having the higher mobility comprise at least one of electrons and holes.

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38. (original) A semiconductor device according to Claim 35 wherein said superlattice channel further has a substantially direct energy bandgap.

39. (original) A semiconductor device according to Claim 35 wherein said superlattice channel further comprises a base semiconductor cap layer on an uppermost group of layers.

40. (currently amended) A semiconductor device according to Claim ~~40~~ 39 wherein said gate comprises a gate electrode layer and a gate dielectric layer between said gate electrode layer and said base semiconductor cap layer.

41. (original) A semiconductor device according to Claim 35 wherein all of said base semiconductor portions are a same number of monolayers thick.

42. (original) A semiconductor device according to Claim 35 wherein at least some of said base semiconductor portions are a different number of monolayers thick.

43. (original) A semiconductor device according to Claim 35 wherein all of said base semiconductor portions are a different number of monolayers thick.

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44. (original) A semiconductor device according to Claim 35 wherein the higher charge carrier mobility results from a lower conductivity effective mass for charge carriers in the parallel direction than would otherwise occur.

45. (original) A semiconductor device according to Claim 35 wherein said superlattice channel further comprises at least one type of conductivity dopant therein.

46. (original) A semiconductor device comprising:  
a substrate; and  
at least one MOSFET adjacent said substrate and  
comprising

a superlattice channel comprising a plurality of  
stacked groups of layers, and

source and drain regions laterally adjacent said  
superlattice channel and a gate overlying said superlattice  
channel for causing transport of charge carriers through  
said superlattice channel in a parallel direction relative  
to the stacked groups of layers,

each group of layers of said superlattice channel  
comprising less than eight stacked silicon atomic layers

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defining a silicon portion and an energy band-modifying layer thereon,

said energy-band modifying layer comprising a single oxygen atomic layer constrained within a crystal lattice of adjacent silicon portions.

47. (original) A semiconductor device according to Claim 46 wherein said superlattice channel further comprises a base semiconductor cap layer on an uppermost group of layers.

48. (original) A semiconductor device according to Claim 47 wherein said gate comprises a gate electrode layer and a gate dielectric layer between said gate electrode layer and said base semiconductor cap layer.

49. (original) A semiconductor device according to Claim 46 wherein all of said base semiconductor portions are a same number of atomic layers thick.

50. (original) A semiconductor device according to Claim 46 wherein at least some of said base semiconductor portions are a different number of atomic layers thick.

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51. (original) A semiconductor device according to Claim 46 wherein all of said base semiconductor portions are a different number of atomic layers thick.

52. (original) A semiconductor device according to Claim 46 wherein said superlattice channel further comprises at least one type of conductivity dopant therein.

53. (original) A semiconductor device comprising:  
a substrate; and  
at least one MOSFET adjacent said substrate and  
comprising

a superlattice channel including a plurality of stacked groups of layers, and

source and drain regions laterally adjacent said superlattice channel and a gate overlying said superlattice channel for causing transport of charge carriers through said superlattice channel in a parallel direction relative to the stacked groups of layers,

each group of layers of said superlattice channel comprising a plurality of stacked base semiconductor monolayers defining a base semiconductor portion and an energy band-modifying layer thereon,

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said energy-band modifying layer comprising at least one non-semiconductor monolayer constrained within a crystal lattice of adjacent base semiconductor portions so that said superlattice channel has a lower conductivity effective mass for charge carriers in the parallel direction than would otherwise be present.

54. (original) A semiconductor device according to Claim 53 wherein said superlattice channel has a common energy band structure therein.

55. (original) A semiconductor device according to Claim 53 wherein the charge carriers having the lower conductivity effective mass comprise at least one of electrons and holes.

56. (original) A semiconductor device according to Claim 53 wherein each base semiconductor portion comprises silicon.

57. (original) A semiconductor device according to Claim 53 wherein each energy band-modifying layer comprises oxygen.

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58. (original) A semiconductor device according to Claim 53 wherein each energy band-modifying layer is a single monolayer thick.

59. (original) A semiconductor device according to Claim 53 wherein each base semiconductor portion is less than eight monolayers thick.

60. (original) A semiconductor device according to Claim 53 wherein each base semiconductor portion is two to six monolayers thick.

61. (original) A semiconductor device according to Claim 53 wherein said superlattice further has a substantially direct energy bandgap.

62. (original) A semiconductor device according to Claim 53 wherein said superlattice further comprises a base semiconductor cap layer on an uppermost group of layers.

63. (original) A semiconductor device according to Claim 62 wherein said gate comprises a gate electrode layer and a gate dielectric layer between said gate electrode layer and said base semiconductor cap layer.

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64. (original) A semiconductor device according to Claim 53 wherein all of said base semiconductor portions are a same number of monolayers thick.

65. (original) A semiconductor device according to Claim 53 wherein at least some of said base semiconductor portions are a different number of monolayers thick.

66. (original) A semiconductor device according to Claim 53 wherein all of said base semiconductor portions are a different number of monolayers thick.

67. (original) A semiconductor device according to Claim 53 wherein each non-semiconductor monolayer is thermally stable through deposition of a next layer.

68. (original) A semiconductor device according to Claim 53 wherein each base semiconductor portion comprises a base semiconductor selected from the group consisting of Group IV semiconductors, Group III-V semiconductors, and Group II-VI semiconductors.



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69. (original) A semiconductor device according to Claim 53 wherein each energy band-modifying layer comprises a non-semiconductor selected from the group consisting of oxygen, nitrogen, fluorine, and carbon-oxygen.

70. (original) A semiconductor device according to Claim 53 wherein the lower conductivity effective mass is less than two-thirds the conductivity effective mass that would otherwise occur.

71. (original) A semiconductor device according to Claim 53 wherein said superlattice further comprises at least one type of conductivity dopant therein.